

AEC-Q200 This component was always RoHS compliant from the first

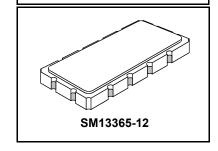
date of manufacture.

RoHS

Compliant

SF2229A

70 MHz SAW Filter



· Precision IF SAW Filter

- Hermetic 13.3 x 6.5 mm Surface-mount Case
- Complies with Directive 2002/95/EC (RoHS)

Absolute Maximum Ratings

Rating	Value	Units	
Maximum Incident Power in Passband	+20	dBm	
Maximum DC Voltage on any Non-ground Terminal	10	VDC	
Storage Temperature Range of Component	-55 to +95 °C		
Storage Temperature Range in Tape and Reel -40 to +85 °C			
Suitable for Lead-free Soldering - Maximum Soldering Profile	260 °C for 30 s		

Electrical Characteristics

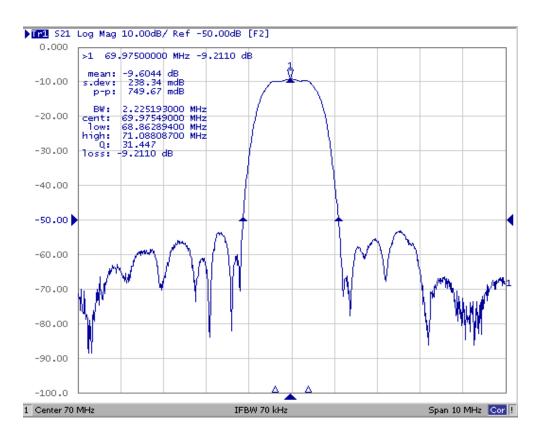
Characteristic	Sym	Notes	Min	Тур	Max	Units
Center Frequency	f _C		69.9	70.0	70.1	
1 dB Bandwidth	BW ₁		0.8	0.92		MHz
3 dB Bandwidth	BW ₃		1.1	1.2		
40 dB Bandwidth	BW ₄₀			2.2	2.3	
Insertion Loss	IL			10.5	12.0	dB
Amplitude Ripple, f _C ± 0.3 MHz				0.7	1.2	dB _{P-P}
Group Delay Ripple, f _C ± 0.3 MHz				350	400	ns _{P-P}
Relative Attenuation:						
10 to 65 MHz			45	55		dB
75 to 200 MHz			45	55		
Operating Temperature Range			-55		+95	°C
Frequency Temperature Coefficient				-94		ppm/°C

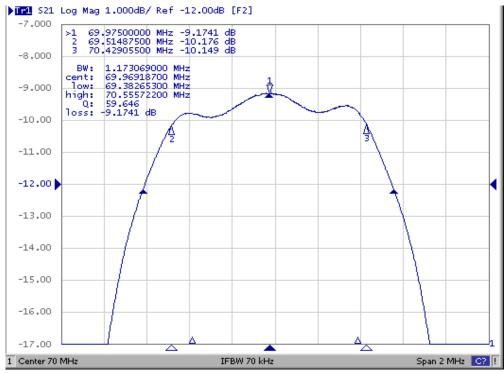
Impedance Matching to 50 Ω Unbalanced Source/Load	External L-C			
Case Style	SM13365-12 13.3 x 6.5 mm Nominal Footprint			
Lid Symbolization (YY = year, WW = week, S = shift)	RFM, SF2229A, <u>YYWWS</u>			

▲ CAUTION: Electrostatic Sensitive Device. Observe precautions for handling. NOTES:

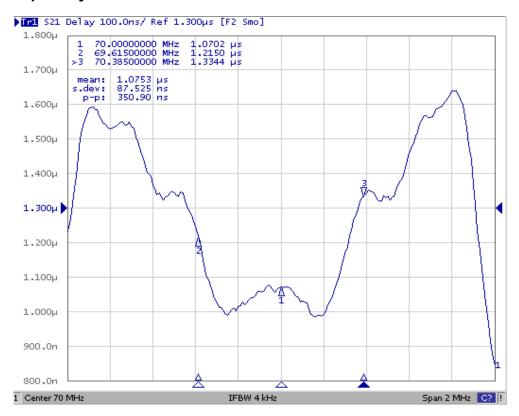
- 1. The design, manufacturing process, and specifications of this device are subject to change.
- 2. US or International patents may apply.
- 3. RoHS compliant from the first date of manufacture.

Filter Amplitude Response Plots

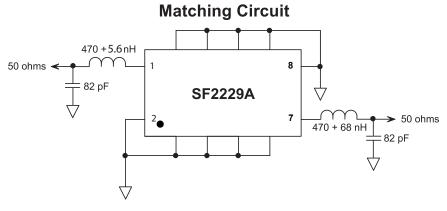




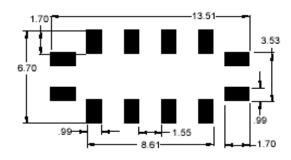
Filter Group Delay Plot



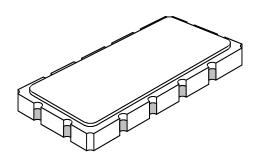
Tuning Component Values



PCB Pad Layout



SM13365-12 Ceramic Surface-mount 12-Terminal Case 13.3 x 6.5 mm Nominal Footprint



Electrical Connections

Connection	Terminals			
Input	1			
Input Ground	2			
Output	7			
Output Ground	8			
Case Ground	3, 4, 5, 6, 9, 10, 11, 12			

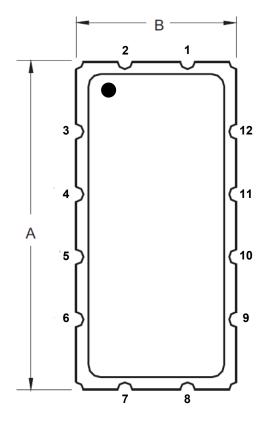
Case Dimensions

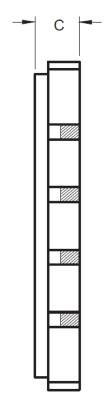
Dimension	mm			Inches		
	Min	Nom	Max	Min	Nom	Max
Α	13.10	13.30	13.50	0.516	0.524	0.531
В	6.30	6.50	6.70	0.248	0.256	0.264
С			1.80			0.071
D		1.50			0.059	
E		0.80			0.031	
Н		0.80			0.031	
Р		2.54			0.100	

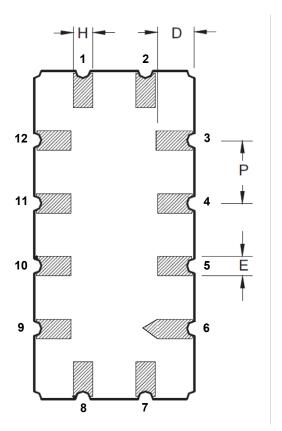
Case Material

Materials			
Solder Pad Plating	0.3 to 1.0 μm Gold over 1.27 to 8.89 μm Nickel		
Lid Plating	2.0 to 3.0 µm Nickel		
Body	Al ₂ O ₃ Ceramic		
Pb Free			

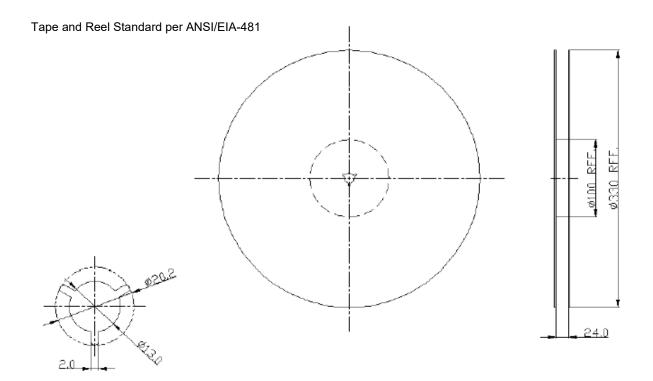
Case Outline Drawing



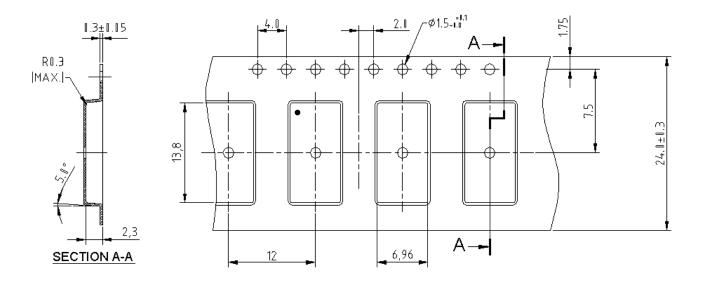




Tape and Reel Specifications



13.3X6.5



Recommended Reflow Profile

- 1. Preheating shall be fixed at 150~180°C for 60~90 seconds.
- 2. Ascending time to preheating temperature 150°C shall be 30 seconds min.
- 3. Heating shall be fixed at 220°C for 50~80 seconds and at 260°C +0/-5°C peak (10 seconds).
- 4. Time: 5 times maximum.

